

<Intelligent Power Modules>

# PM50RG1B120

FLAT-BASE TYPE INSULATED PACKAGE



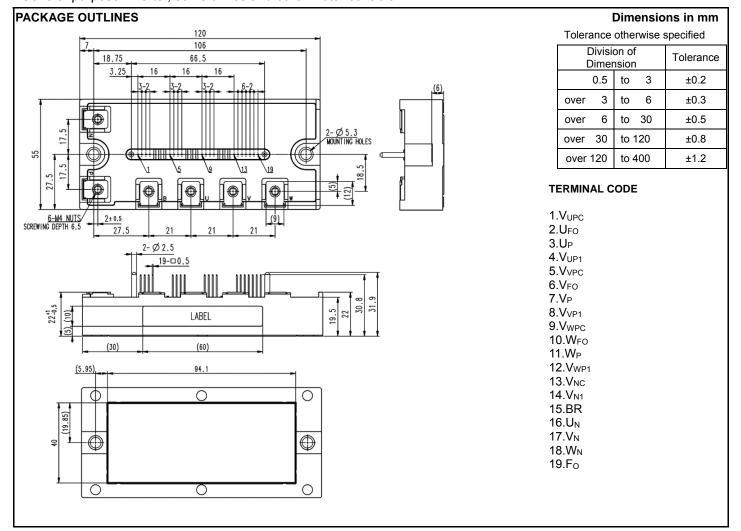
#### **FEATURE**

- a) Adopting Full-Gate CSTBT™ chip.
- b) The over-temperature protection which detects the chip surface temperature of CSTBT™ is adopted.
- c) Error output signal is available from each protection upper and lower arm of IPM.
- d) Outputting an error signal corresponding to the abnormal state (error mode identification)

UL Recognized under UL1557, File No. E323585
This product is compliant with the Restriction of the Use of Certain Hazardous Substances in Electrical and Electronic Equipment (RoHS) directive 2011/65/EU.

#### **APPLICATION**

General purpose inverter, servo drives and other motor controls



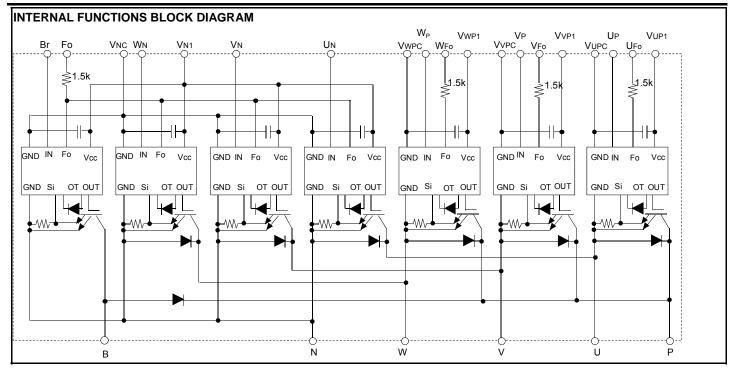
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Publication date: Nov, 2017

# PM50RG1B120

HIGH POWER SWITCHING USE

**INSULATED TYPE** 



### **MAXIMUM RATINGS** (Tvj = 25°C, unless otherwise noted)

#### **INVERTER PART**

1144514151	(170)			
Symbol	Parameter	Conditions	Ratings	Unit
V <sub>CES</sub>	Collector-Emitter Voltage	V <sub>D</sub> =15 V, V <sub>CIN</sub> =15 V	1200	V
Ic	Collector Current	T <sub>C</sub> =25 °C	50	^
I <sub>CRM</sub>	Collector Current	Pulse	100	Α
$P_{tot}$	Total Power Dissipation	T <sub>C</sub> =25 °C	378	W
I <sub>E</sub>	Emitter Current	T <sub>C</sub> =25 °C	50	^
I <sub>ERM</sub>	(Free-wheeling Diode Forward current)	Pulse	100	Α
Tvj	Junction Temperature		-20 ~ +150	°C

<sup>\*:</sup> Tc measurement point is just under the chip.

#### **BRAKE PART**

Symbol	Parameter	Conditions	Ratings	Unit
V <sub>CES</sub>	Collector-Emitter Voltage	V <sub>D</sub> =15 V, V <sub>CIN</sub> =15 V	1200	V
I <sub>C</sub>	Callantan Cumant	T <sub>C</sub> =25 °C	25	
I <sub>CRM</sub>	Collector Current	Pulse	50	A
P <sub>tot</sub>	Total Power Dissipation	T <sub>C</sub> =25 °C	260	W
V <sub>R(DC)</sub>	Diode Rated Reverse DC Voltage	T <sub>C</sub> =25 °C	1200	V
I <sub>F</sub>	Diode Forward Current	T <sub>C</sub> =25 °C	25	Α
T <sub>j</sub>	Junction Temperature		-20 ~ +150	°C

<sup>\*:</sup> Tc measurement point is just under the chip.

# **CONTROL PART**

Symbol	Parameter	Conditions	Ratings	Unit
$V_D$	Supply Voltage	Applied between: V <sub>UP1</sub> -V <sub>UPC</sub> , V <sub>VP1</sub> -V <sub>VPC</sub> , V <sub>WP1</sub> -V <sub>WPC</sub> , V <sub>N1</sub> -V <sub>NC</sub>	20	V
$V_{CIN}$	Input Voltage	Applied between: U <sub>P</sub> -V <sub>UPC</sub> , V <sub>P</sub> -V <sub>VPC</sub> , W <sub>P</sub> -V <sub>WPC</sub> , U <sub>N</sub> , V <sub>N</sub> , W <sub>N</sub> , Br -V <sub>NC</sub>	20	V
$V_{FO}$	Fault Output Supply Voltage	Applied between: U <sub>FO</sub> -V <sub>UPC</sub> , V <sub>FO</sub> -V <sub>VPC</sub> , W <sub>FO</sub> -V <sub>WPC</sub> , Fo-V <sub>NC</sub>	20	V
I <sub>FO</sub>	Fault Output Current	Sink current at U <sub>FO</sub> , V <sub>FO</sub> , W <sub>FO</sub> , Fo terminals	20	mA

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HIGH POWER SWITCHING USE

#### INSULATED TYPE

# TOTAL SYSTEM

Symbol	Parameter	Conditions	Ratings	Unit
V <sub>CC(PROT)</sub>	Supply Voltage Protected by SC	V <sub>D</sub> =13.5 V~16.5 V, Inverter Part, Tvj=+125°C start	800	V
$T_{stg}$	Storage Temperature	-	-40 ~ +125	°C
Tc	Operating Case Temperature	-	-20 ~ +125	°C
V <sub>isol</sub>	Isolation Voltage	60Hz, Sinusoidal, Charged part to Base plate, AC 1min, RMS	2500	V

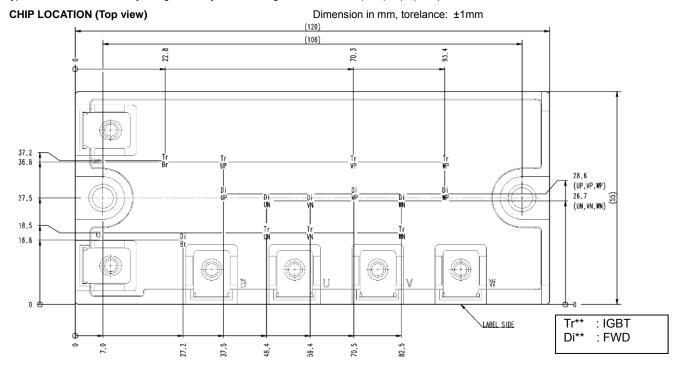
<sup>\*:</sup> Tc measurement point is just under the chip.

### THERMAL RESISTANCE

Symbol	Parameter	Conditions	Limits			Linit
		Conditions	Min.	Тур.	Max.	Unit
$R_{th(j-c)Q}$		Inverter, Junction to case, IGBT, per 1 element (Note1)	-	-	0.33	
$R_{th(j-c)D}$		Inverter, Junction to case, FWD, per 1 element (Note1)	-	-	0.51	K/W
$R_{th(j-c)Q}$	Thermal Resistance	Brake, Junction to case, IGBT, per 1 element (Note1)	-	-	0.48	I IVVV
$R_{th(j-c)D}$		Brake, Junction to case, FWD, per 1 element (Note1)	-	-	0.78	
R <sub>th(c-s)</sub>	Contact Thermal Resistance	Case to heat sink, per 1 module,	- 14.4		_	K/kW
		Thermal grease applied (Note.1, 2)	_	17.7		TORVV

Note1. If you use this value,  $R_{\text{th(s-a)}}$  should be measured just under the chips.

Note2. Typical value is measured by using thermally conductive grease of  $\lambda$ =0.9W/(m·K),  $D_{\text{(C-S)}}$ =50  $\mu$ m.



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HIGH POWER SWITCHING USE

INSULATED TYPE

# **ELECTRICAL CHARACTERISTICS** (Tvj= 25°C, unless otherwise noted)

### **INVERTER PART**

Cumbal	Parameter	Conditions			Limits			Unit
Symbol	symbol Parameter Conditions				Min.	Тур.	Max.	Offic
		Y 45 V 4 50 A	T:-25 °C	Terminal	-	-	1.75	
V		V <sub>D</sub> =15 V, I <sub>C</sub> =50 A	Tvj=25 °C	Chip	-	1.3	-	V
V <sub>CEsat</sub>	Collector-Emitter Saturation Voltage	V =0.V Dulgad (Fig. 1)	Tui-125 °C	Terminal	-	-	2.0	V
		V <sub>CIN</sub> =0 V, Pulsed, (Fig.1)	Tvj=125 °C	Chip	-	1.5	-	
		V -15 V I -50 A	Tvj=25 °C	Terminal	-	-	2.35	V
V	Emitter-Collector Voltage	$V_D = 15 \text{ V}, I_E = 50 \text{ A},$	1 Vj-25 C	Chip	-	1.75	-	
$V_{EC}$		V <sub>CIN</sub> = 15 V, pulsed, (Fig.2) Tvj=125 °C	Tvi=125 °C	Terminal	1	-	2.6	
			Chip	1	1.95	ı		
t <sub>on</sub>		V <sub>D</sub> =15 V, V <sub>CIN</sub> =0 V←→15 V,			0.3	0.7	1.2	
t <sub>rr</sub>		V <sub>CC</sub> =600 V, I <sub>C</sub> =50A,			-	0.13	0.4	
t <sub>c(on)</sub>	Switching Time	Tvj=125 °C,			-	0.2	0.4	μs
t <sub>off</sub>		Inductive Load			-	1.0	2.8	
$t_{c(off)}$		(Fig.3, 4)			1	0.4	1.2	
	Collector-Emitter Cut-off Current	\(\begin{align*} \( \begin{align*} \\  \begin{align*} \( \begin{align*} \\  \be		Tvj=25 °C	-	-	1	mΛ
I <sub>CES</sub>				Tvj=125 °C	-	-	10	mA

#### **BRAKE PART**

Cumhal	Parameter	Conditions			Limits			Unit
Symbol	Parameter	Condition	Conditions			Тур.	Max.	Unit
		V <sub>D</sub> =15 V, I <sub>C</sub> =25 A Tvj=25 °C	Terminal	-	-	1.7		
.,		VB-13 V, 16-23 A	1 1 7 2 3 6	Chip	-	1.3	1	.,
V <sub>CEsat</sub>	Collector-Emitter Saturation Voltage	V <sub>CIN</sub> =0 V, Pulsed, (Fig.1)	T.: 405 °C	Terminal	-	-	1.95	V
		V <sub>CIN</sub> -0 V, Fulsed, (Fig. 1)	Tvj=125 °C	Chip	-	1.5	-	
		Tvj=25	Tv:-25 °C	Terminal	-	-	2.35	
\/	Diode Forward Voltage		1 Vj=23 C	Chip	-	1.75	-	V
$V_{FM}$	Diode Forward Voltage		T : 405 00	Terminal	-	-	2.6	V
		Tvj=125 °C		Chip	-	1.95	-	
	0-11	V <sub>CE</sub> =V <sub>CES</sub> , V <sub>D</sub> =15 V, V <sub>CIN</sub> =15 V (Fig.5)		Tvj=25 °C	-	-	1	4
I <sub>CES</sub>	Collector-Emitter Cut-off Current			Tvj=125 °C	-	-	10	mA

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INSULATED TYPE

## **ELECTRICAL CHARACTERISTICS** (Tvj = 25°C, unless otherwise noted)

#### **CONTROL PART**

Cumbal	Parameter	Conditions		Limits			Unit
Symbol	Parameter	Conditions	Conditions		Тур.	Max.	Unit
		V -45 V V -45 V	V <sub>P1</sub> -V <sub>PC</sub>	-	4	6	
	Cinquit Cumant	V <sub>D</sub> =15 V, V <sub>CIN</sub> =15 V	V <sub>N1</sub> -V <sub>NC</sub>	-	16	24	
I <sub>D</sub>	Circuit Current	V <sub>D</sub> =15 V, V <sub>CIN</sub> =0 V←15 V, V <sub>CC</sub> =800 V	V <sub>P1</sub> -V <sub>PC</sub>	-	16	20	mA
		I <sub>C</sub> =0A, Tvj=125 °C, f <sub>C</sub> ≤20kHz	V <sub>N1</sub> -V <sub>NC</sub>	-	59	71	
$V_{th(ON)}$	Input ON Threshold Voltage	Applied between:		1.2	1.5	1.8	V
$V_{th(OFF)}$	Input OFF Threshold Voltage	$ U_{P}\text{-}V_{UPC}, \ V_{P}\text{-}V_{VPC}, \ W_{P}\text{-}V_{WPC}, \ U_{N}, \ V_{N}, \ W_{N}, $	Br-V <sub>NC</sub>	1.7	2.0	2.3	V
00	Short Circuit Trip Level	00 (Tail (405 °C) )	Inverter	100	-	-	_
SC		-20≤Tvj≤125 °C, V <sub>D</sub> =15 V (Fig.3, 6)	Brake	50	-	-	Α
t <sub>d(SC)</sub>	Short Circuit Current Delay Time	V <sub>D</sub> =15 V, Tvj=125 °C (Fig.3, 6)	V <sub>D</sub> =15 V, Tvj=125 °C (Fig.3, 6)		2.0	-	μs
ОТ	0 7 1 5 1 11	Detect to many exerting of ICDT objection conferen	Trip level	150	-	-	°C
OT <sub>(hys)</sub>	Over Temperature Protection	Detect temperature of IGBT chip surface	Hysteresis	-	20	-	
UV <sub>t</sub>	Supply Circuit		Trip level	11.0	12.0	12.7	V
UV <sub>r</sub>	Under-Voltage Protection	-	Reset level	-	12.5	-	V
I <sub>FO(H)</sub>	Facility Contract Comment	V 45 V V 45 V (N-4-0)		-	-	0.01	
I <sub>FO(L)</sub>	Fault Output Current	V <sub>D</sub> =15 V, V <sub>FO</sub> =15 V (Note3)		-	10	15	- mA
			ОТ	-	8.0	-	
t <sub>FO</sub>	Fault Output Pulse Width	V <sub>D</sub> =15 V (Note3)	UV	-	4.0	-	ms
			SC	-	2.0	-	

Note3. Fault output is given only when the internal SC, OT & UV protections schemes of either upper or lower arm device operate to protect it.

#### **MECHANICAL RATINGS AND CHARACTERISTICS**

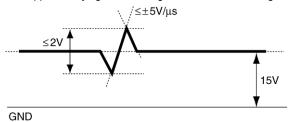
Symbol	Parameter	Conditions	Limits			Unit
		Conditions	Min.	Тур.	Max.	UTIIL
Ms	Mounting Torque	Mounting part screw : M5	2.5	3.0	3.5	N•m
$M_t$	Mounting Torque	Main terminal part screw : M4	1.5	1.7	2.0	INTIII
m	mass	-	-	260	-	g

#### **RECOMMENDED CONDITIONS FOR USE**

Symbol	Parameter	Conditions	Recommended value	Unit
V <sub>CC</sub>	Supply Voltage	Applied across P-N terminals	≤ 800	V
V <sub>D</sub>	Control Supply Voltage	Applied between : V <sub>UP1</sub> -V <sub>UPC</sub> , V <sub>VP1</sub> -V <sub>VPC</sub> , V <sub>WP1</sub> -V <sub>WPC</sub> , V <sub>N1</sub> -V <sub>NC</sub> (Note4)	15.0±1.5	V
V <sub>CIN(ON)</sub>	Input ON Voltage	Applied between :	≤ 0.8	V
$V_{CIN(OFF)}$	Input OFF Voltage	$U_{P}$ - $V_{UPC}$ , $V_{P}$ - $V_{VPC}$ , $W_{P}$ - $V_{WPC}$ , $U_{N}$ , $V_{N}$ , $W_{N}$ , $Br$ - $V_{NC}$	≥ 9.0	]
f <sub>PWM</sub>	PWM Input Frequency	Using Application Circuit of Fig. 8	≤ 20	kHz
t <sub>dead</sub>	Arm Shoot-through Blocking Time	For IPM's each input signals (Fig.7)	≥ 2.5	μs

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Note4. With ripple satisfying the following conditions: dv/dt swing ≤ ±5 V/µs, Variation ≤ 2 V peak to peak



#### PRECAUTIONS FOR TESTING

- 1. Before applying any control supply voltage (V<sub>D</sub>), the input terminals should be pulled up by resistors, etc. to their corresponding supply voltage and each input signal should be kept off state.
  - After this, the specified ON and OFF level setting for each input signal should be done.
- 2. When performing "SC" tests, the turn-off surge voltage spike at the corresponding protection operation should not be allowed to rise above V<sub>CES</sub> rating of the device.

(These test should not be done by using a curve tracer or its equivalent.)

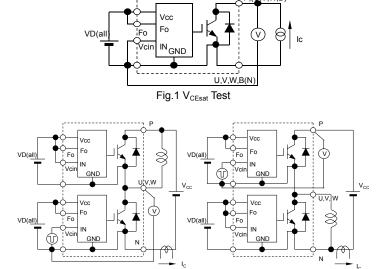
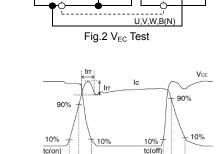


Fig.3 Switching time and SC test circuit



(ton = td(on) + tr) (toff = td(off) + tf)Fig.4 Switching time test waveform

td(off)

td(on)

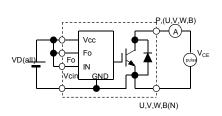


Fig.5 I<sub>CES</sub> Test

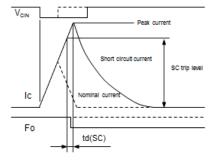
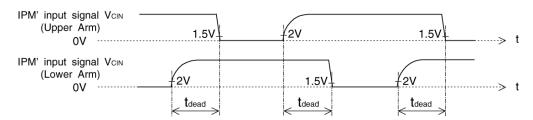
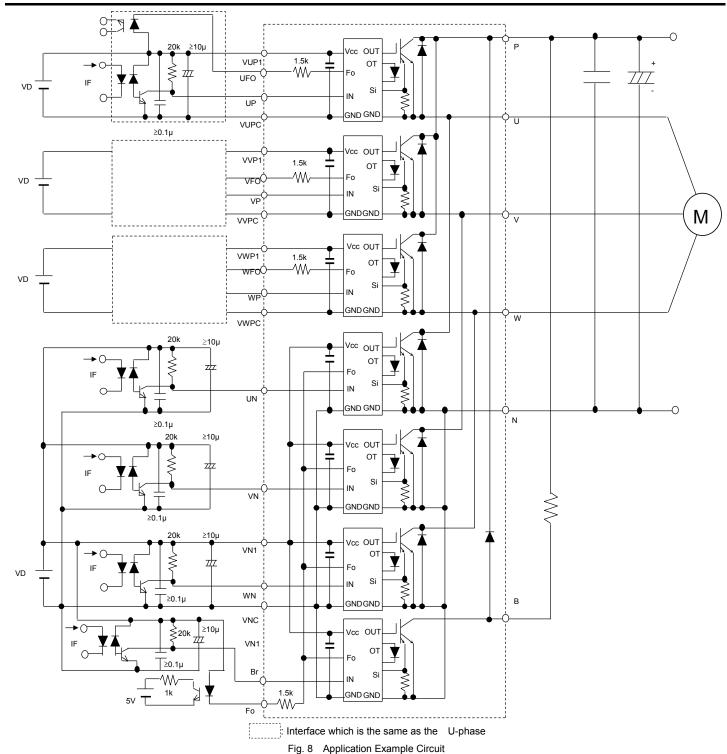


Fig.6 SC test waveform



1.5V: Input on threshold voltage Vth(on) typical value, 2V: Input off threshold voltage Vth(off) typical value

Fig. 7 Dead time measurement point example

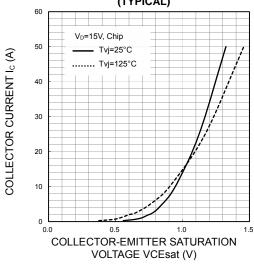


#### NOTES FOR STABLE AND SAFE OPERATION;

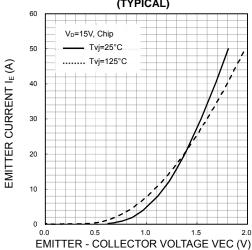
- Design the PCB pattern to minimize wiring length between opto-coupler and IPM's input terminal, and also to minimize the stray capacity between the input and output wirings of opto-coupler.
- · Connect low impedance capacitor between the Vcc and GND terminal of each fast switching opto-coupler.
- Fast switching opto-couplers:  $t_{PLH}$ ,  $t_{PHL} \le 0.8 \mu s$ , Use High CMR type.
- Slow switching opto-coupler: CTR > 100% (\*can be applied to Brake part input signal, in this case, resistor should be selected properly).
- Use 4 isolated control power supplies (V<sub>D</sub>). Also, care should be taken to minimize the instantaneous voltage charge of the power supply.
- Make inductance of DC bus line as small as possible, and minimize surge voltage using snubber capacitor between P and N terminal.



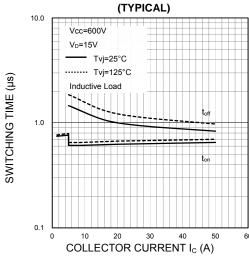




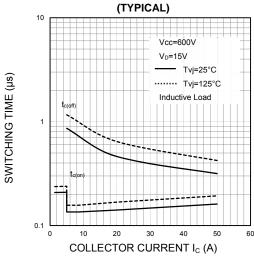
#### FREE WHEELING DIODE FORWARD CHARACTERISTICS (TYPICAL)



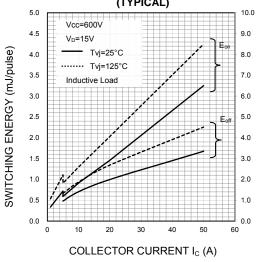
# SWITCHING TIME (ton, toff) CHARACTERISTICS



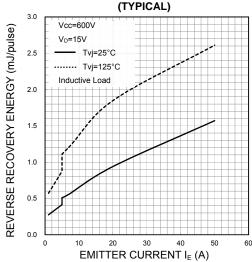
# SWITCHING TIME (t<sub>c(on)</sub>, t<sub>c(off)</sub>) CHARACTERISTICS (TYPICAL)

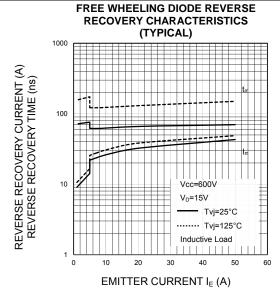


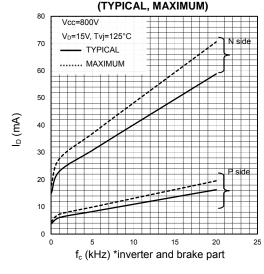
# SWITCHING ENERGY CHARACTERISTICS (TYPICAL)



# FREE WHEELING DIODE REVERSE RECOVERY ENERGY CHARACTERISTICS

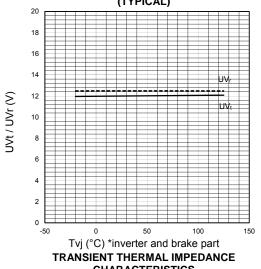




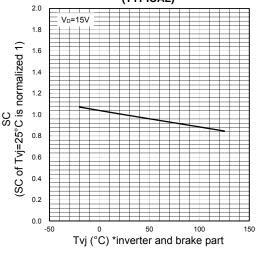


ID VS. fc CHARACTERISTICS

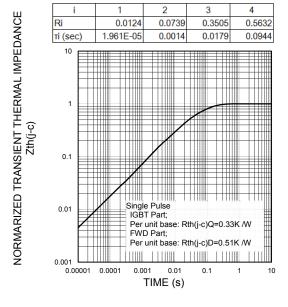
#### **UV TRIP LEVEL VS. Tvj CHARACTERISTICS** (TYPICAL)







# **CHARACTERISTICS** (TYPICAL)

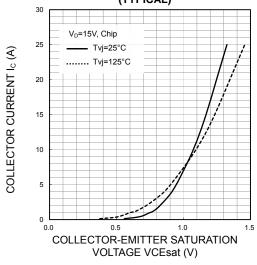


NORMARIZED TRANSIENT THERMAL IMPEDANCE

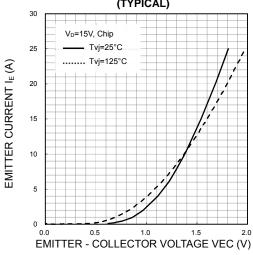
#### INSULATED TYPE

# PERFORMANCE CURVES Brake part

#### COLLECTOR-EMITTER SATURATION VOLTAGE (VS. Ic) CHARACTERISTICS (TYPICAL)



#### FREE WHEELING DIODE FORWARD CHARACTERISTICS (TYPICAL)



#### TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS (TYPICAL)

	i	1	2	3	4					
	Ri	0.0124	0.0739	0.3505	0.5632					
	ті (sec)	1.961E-05	0.0014	0.0179	0.0944					
	10	10								
	1									
		####								
်										
Zth(j-c)			-							
Ţ	0.1									
	0.01	Singl	le Pulse	11111111. 1111	1111					
	"" <i>/</i>		T Part;	H- (: -) O O A	014 004					
			unit base: R D Part;	ting-c)Q=0.4	on /vv					
			unit base: R	th(j-c)D=0.7	8K /W					
	0.001									
	0.00001	0.0001 0.0	01 0.01	0.1	1 10					
			TIME (s)							

# PM50RG1B120

HIGH POWER SWITCHING USE INSULATED TYPE

#### Keep safety first in your circuit designs!

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